

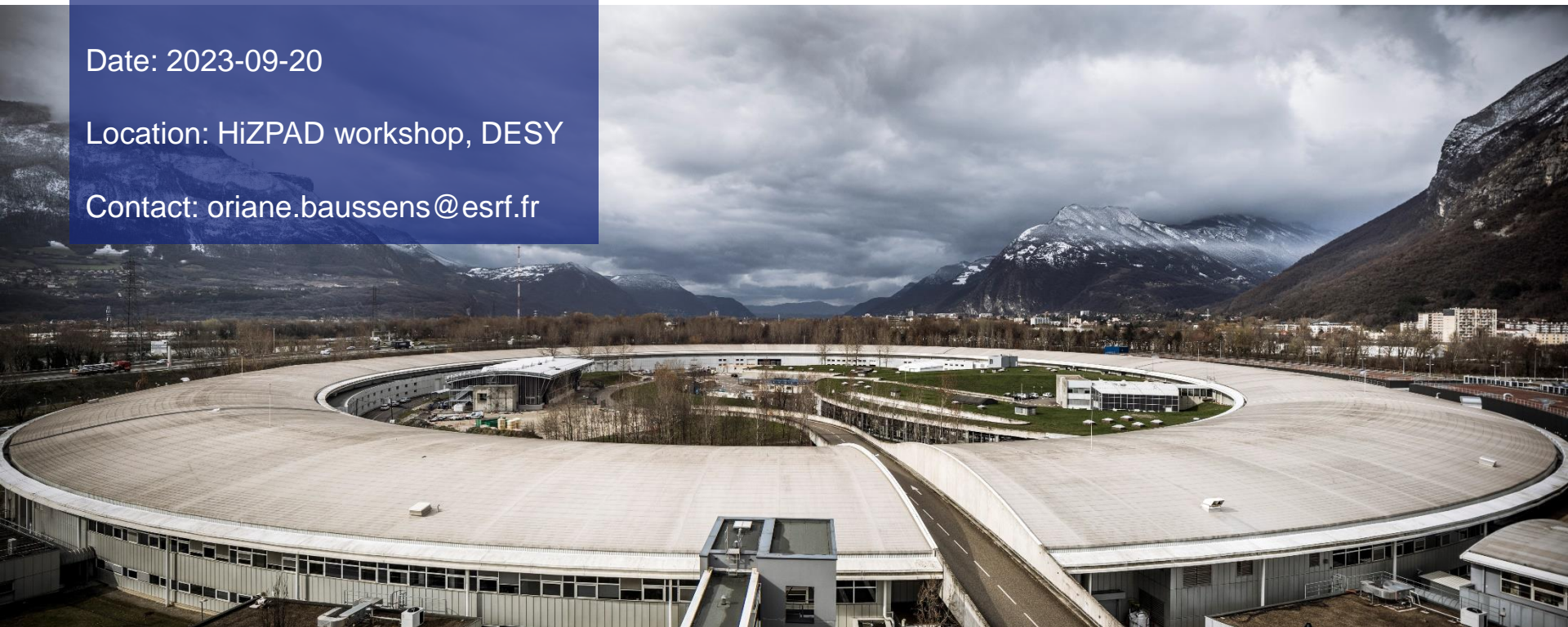
# Characterization and comparison of GaAs:Cr sensors coupled to Timepix family chips

Author: Oriane Baussens

Date: 2023-09-20

Location: HiZPAD workshop, DESY

Contact: [oriane.baussens@esrf.fr](mailto:oriane.baussens@esrf.fr)



## 1. Context

## 2. Characterizations and comparisons

1. Flood images and flat field correction
2. Linearity with incident X-ray flux
3. Charge transport properties

## 3. Conclusion and outlook

## 1. Context

## 2. Characterizations and comparisons

1. Flood images and flat field correction
2. Linearity with incident X-ray flux
3. Charge transport properties

## 3. Conclusion and outlook



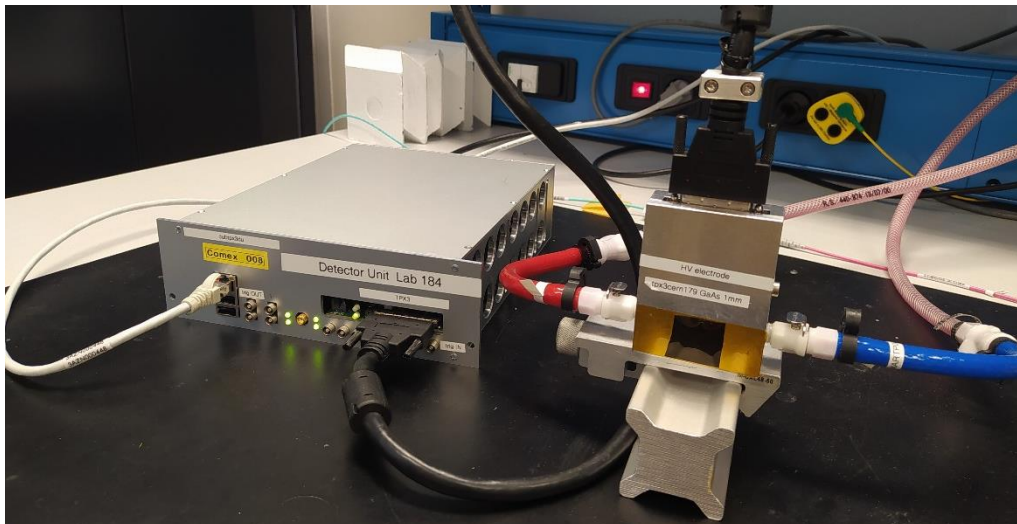
- Readout systems used at the ESRF

- Timepix: MAXIPIX



	Timepix
Tech. node (nm)	250
Year	2005
Pixel size ( $\mu\text{m}$ )	55
# pixels (x x y)	256 x 256
Time bin (resolution)	10ns
Readout architecture	Frame based (sequential R/W)
Number of sides for tiling	3

- Timepix3:



	Timepix3
Tech. node (nm)	130
Year	2014
Pixel size ( $\mu\text{m}$ )	55
# pixels (x x y)	256 x 256
Time bin (resolution)	1.6ns
Readout architecture	Data driven or Frame based (sequential R/W)
Number of sides for tiling	3

## 1. Context

## 2. Characterizations and comparisons

1. Flood images and flat field correction
2. Linearity with incident X-ray flux
3. Charge transport properties

## 3. Conclusion and outlook



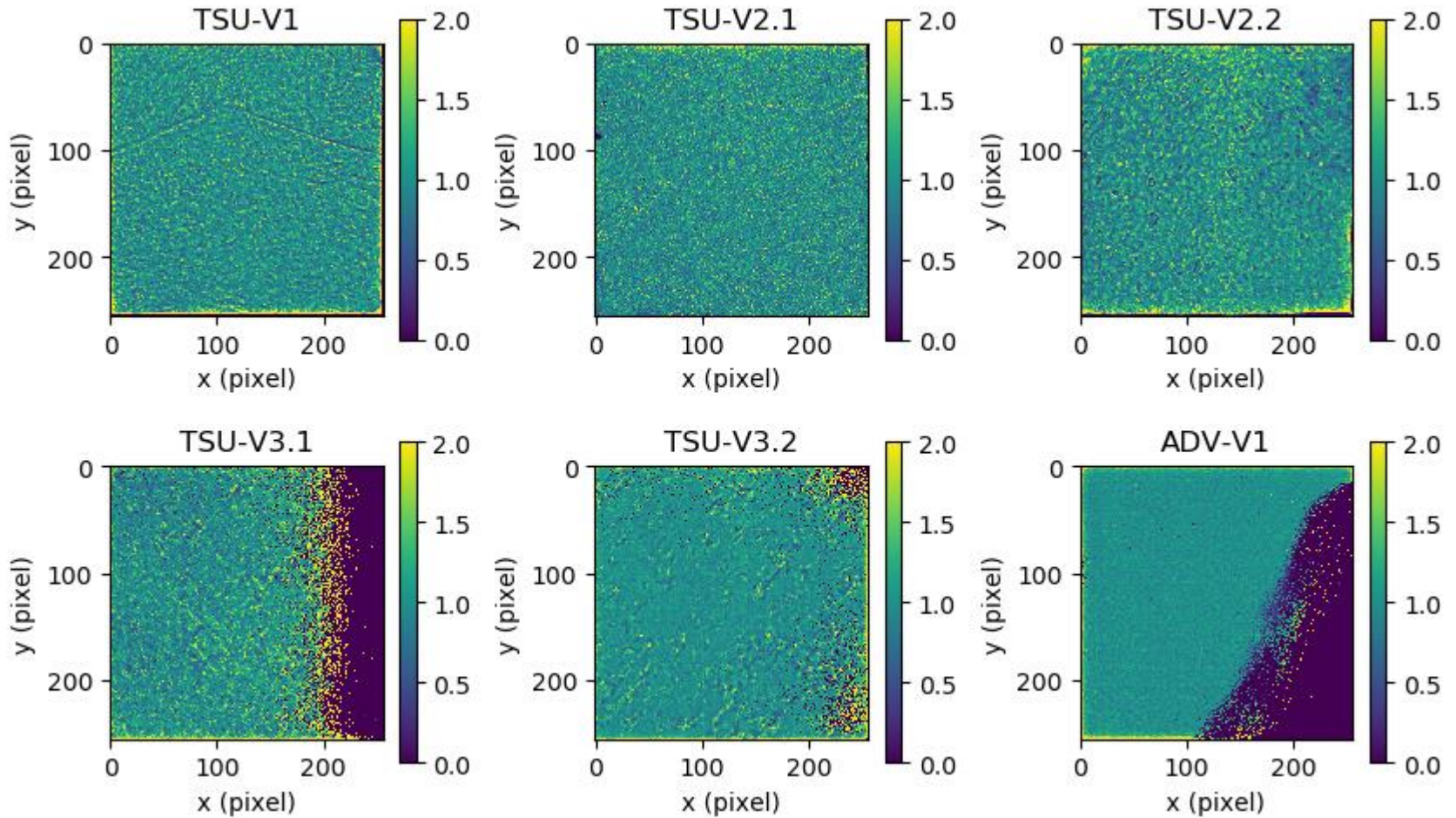
# FLOOD IMAGES AFTER CALIBRATION

Context  
○○

Characterizations and comparisons

●○○○○○ ○○○○○○ ○○○○○○

Conclusion  
○



⇒ Bonding and breakage issues with the most recent detectors



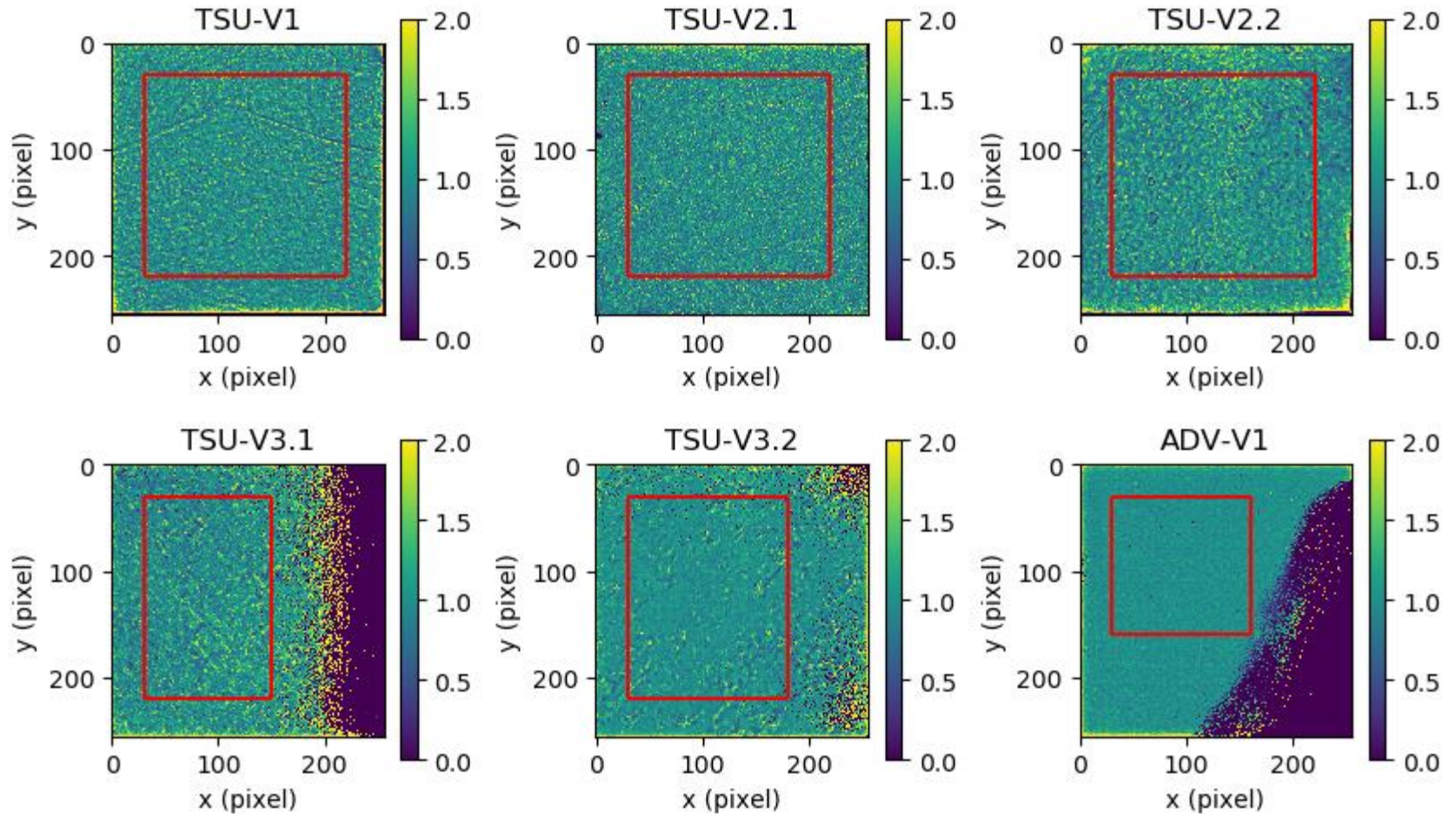
# FLOOD IMAGES AFTER CALIBRATION

Context  
○○

Characterizations and comparisons

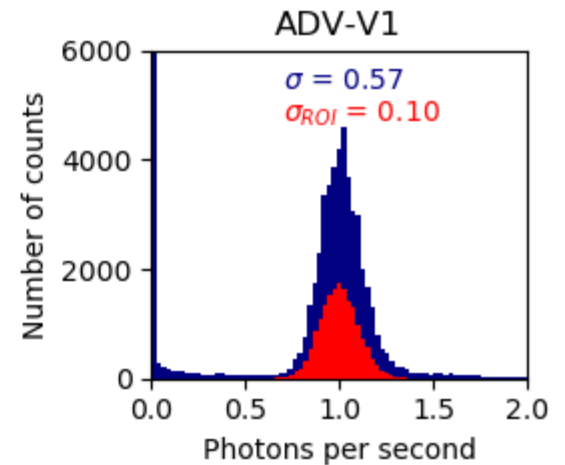
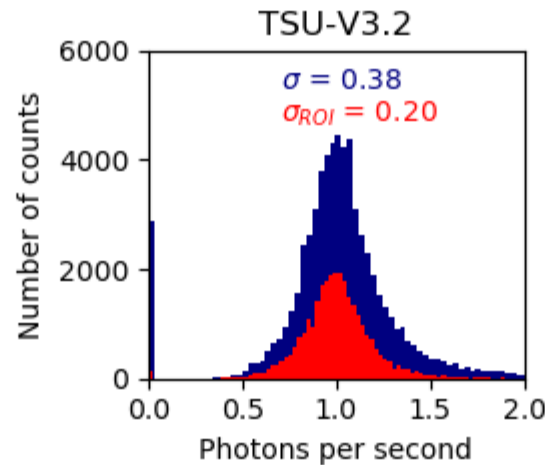
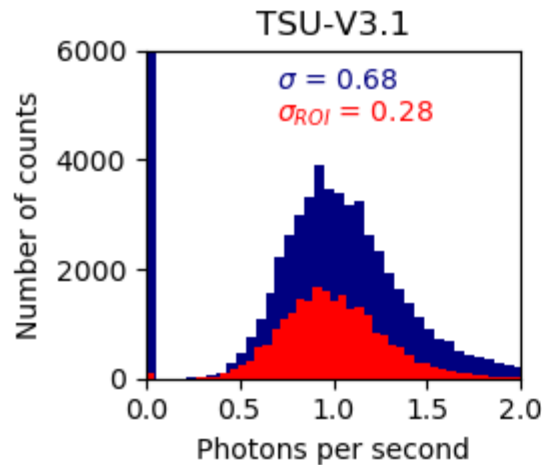
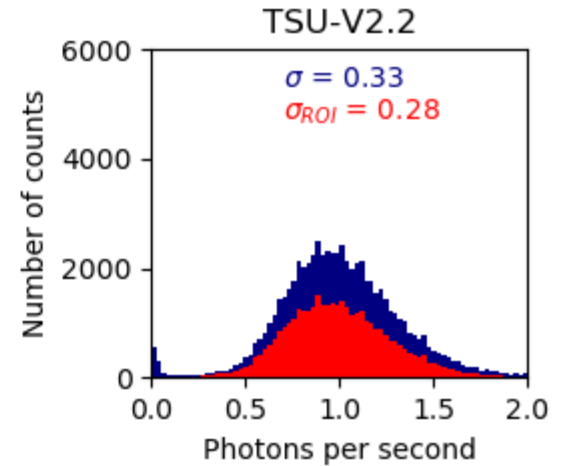
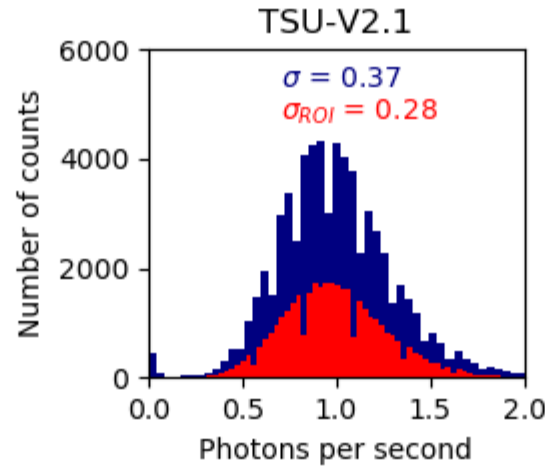
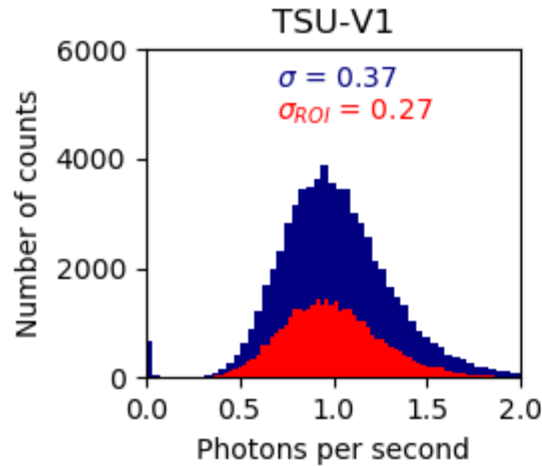
●○○○○○ ○○○○ ○○○○

Conclusion  
○



- ⇒ Bonding and breakage issues with the most recent detectors
- ⇒ Characterizations on the ROI in red

# FLOOD IMAGES AFTER CALIBRATION



⇒ The most homogenous sensors are ADV-V1 and TSU-V3.2 (ROI measurements)

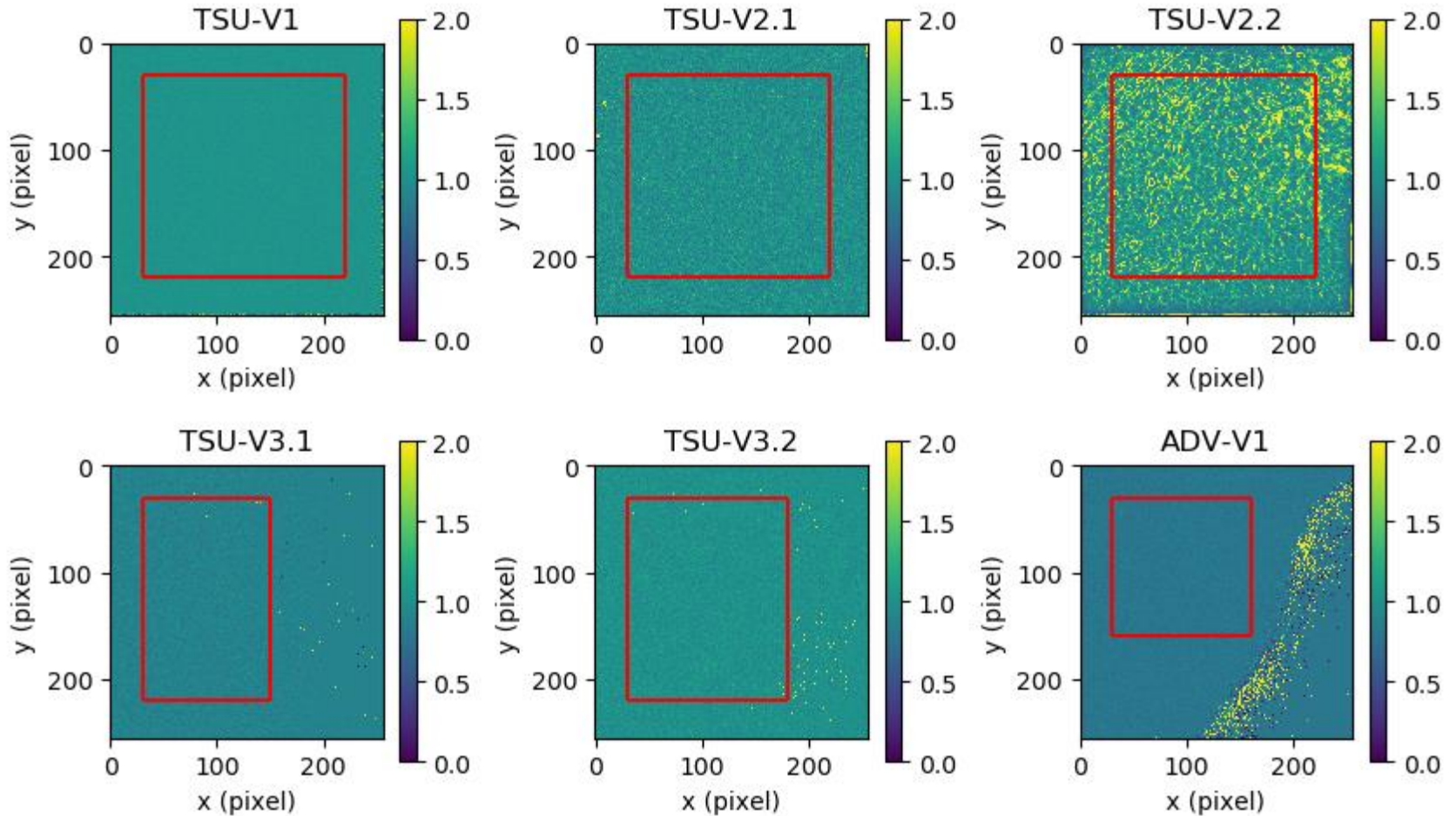
# FLAT FIELD (FF) CORRECTION

Context  
○○

Characterizations and comparisons



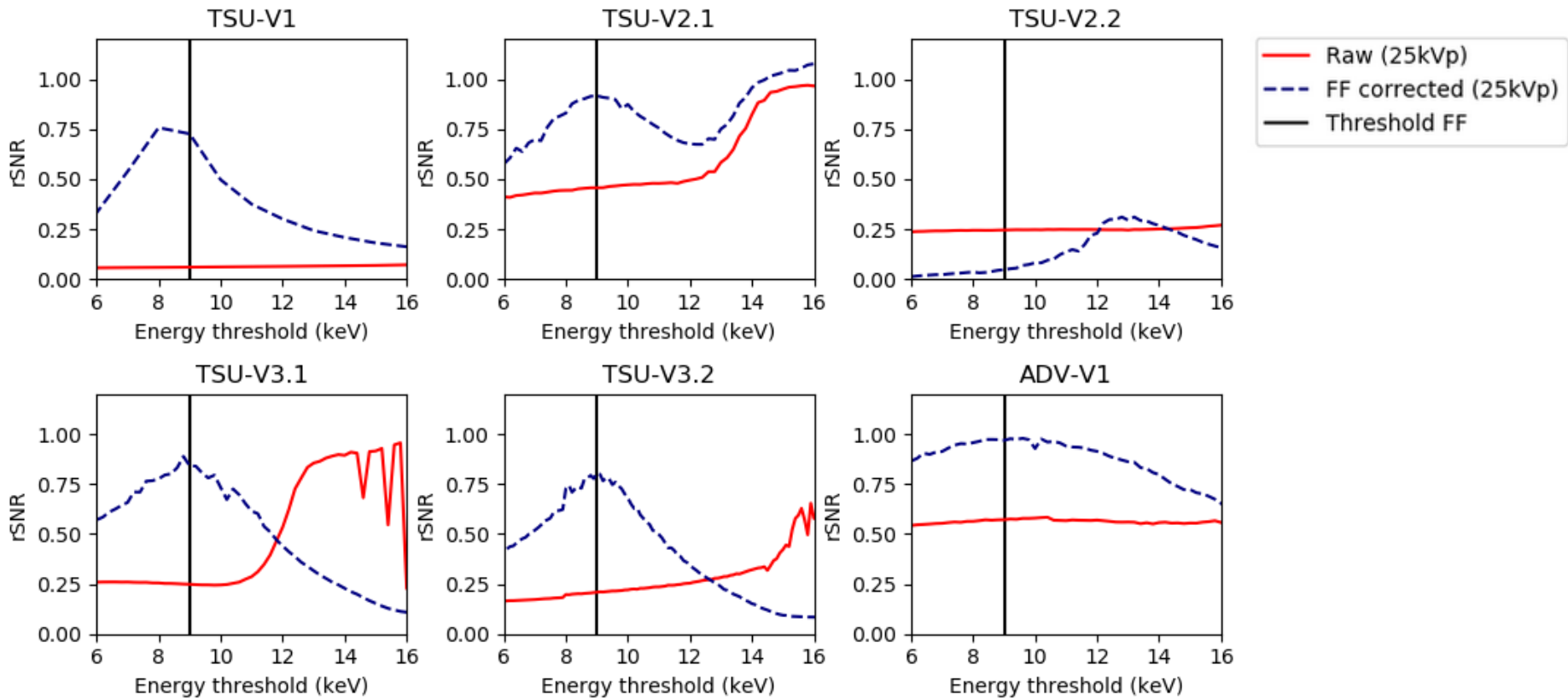
Conclusion  
○



⇒ There is an obvious issue with the flat field correction of TSU-V2.2

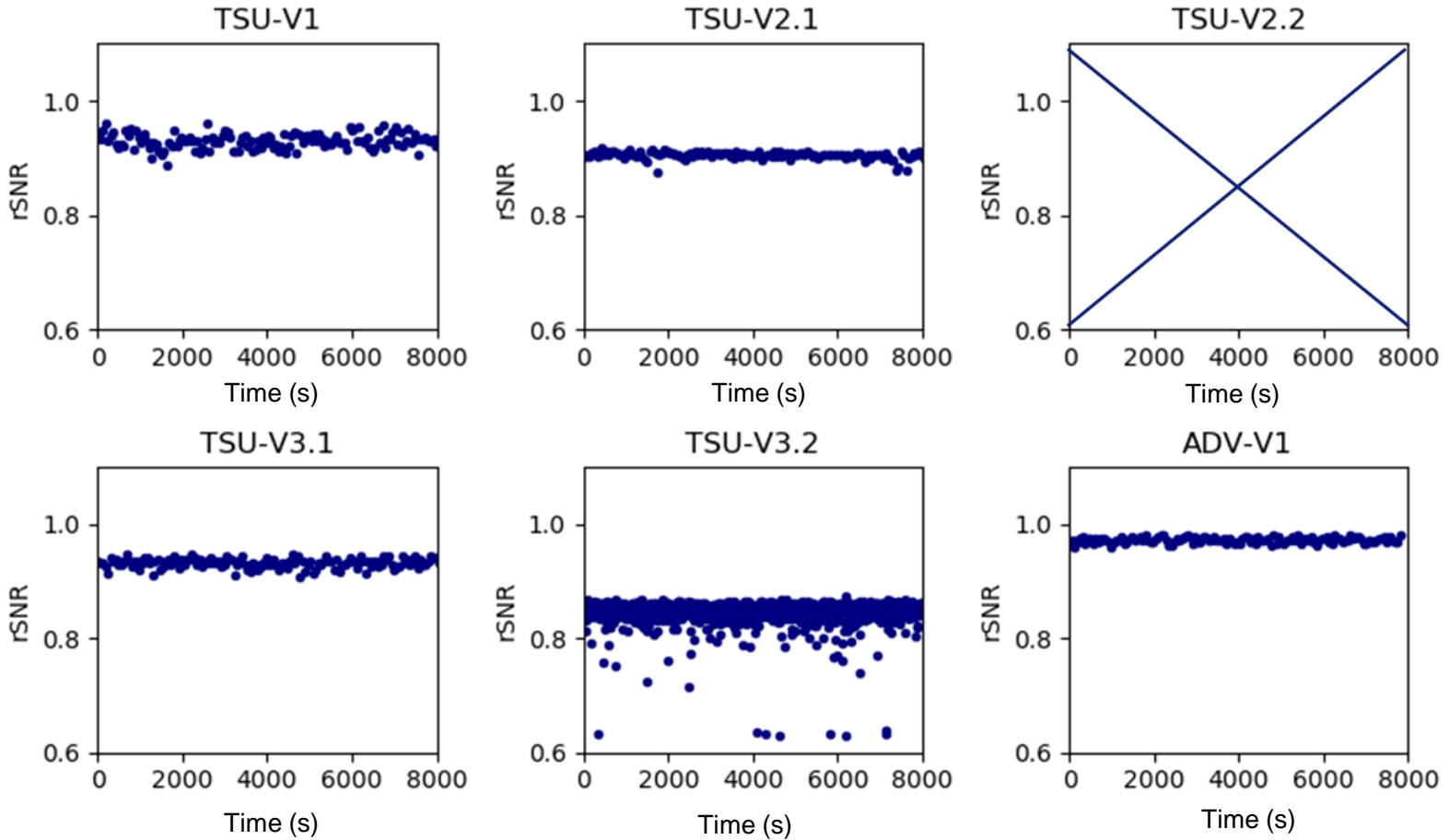
- **Relative Signal-to-Noise Ratio (rSNR)**

$$rSNR(ROI) = \frac{SNR_{image}(ROI)}{SNR_{poisson}(ROI)} = \frac{\sqrt{\text{mean}(ROI)}}{\sigma(ROI)}$$



⇒ The FF correction effectively improves the rSNR for all detectors (except TSU-V2.2)

- **Relative Signal-to-Noise Ratio (rSNR)**



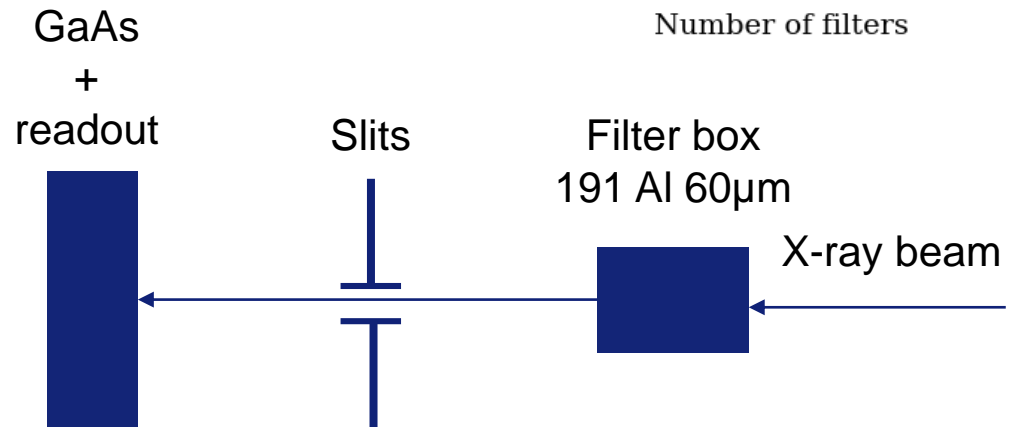
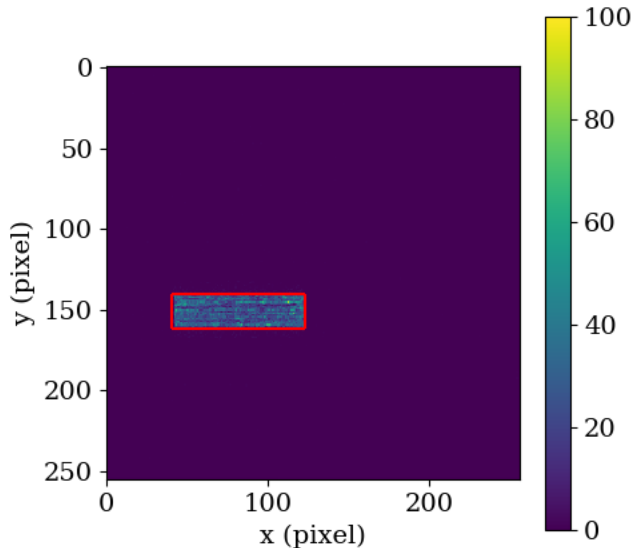
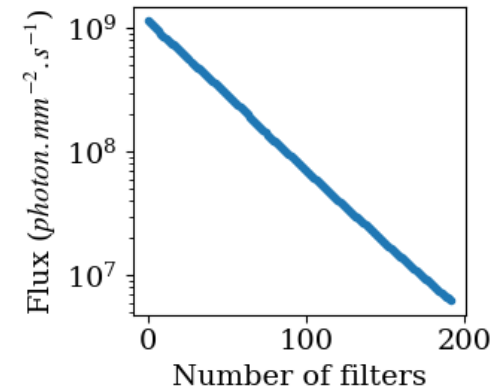
⇒ Most effective and stable FF correction achieved for ADV-V1 followed by TSU-V2.1 and TSU-V3.1

- **Takeaway messages for flood images and flat field correction**
  - The best sensor that we have to date in terms of homogeneity, FF correction efficiency and stability is the sensor from Advacam. BUT, to date we have only characterized one sensor so this still needs to be confirmed.
  - The experience that we have with TSU sensors is that for the same version the detectors the homogeneity and FF correction quality are not necessarily reproducible.

1. Context
- 2. Characterizations and comparisons**
  1. Flood images and flat field correction
  2. Linearity with incident X-ray flux
  3. Charge transport properties
3. Conclusion and outlook

## • Setup for linearity limit measurement

- Source: 30keV monochromatic synchrotron beam provided by the BM05 beamline of the ESRF (7/8+1 mode)
- Detector tested: TSU-V1, TSU-V2.2 and TSU-V3.2
- Flux range:  $2 \times 10^7$  -  $2 \times 10^9$  ph.mm<sup>-2</sup>.s<sup>-1</sup>
- Parameters tested
  - Temperature: 8°C and 20°C
  - Bias: -300V and -700V
  - Ikrum: 10 and 40

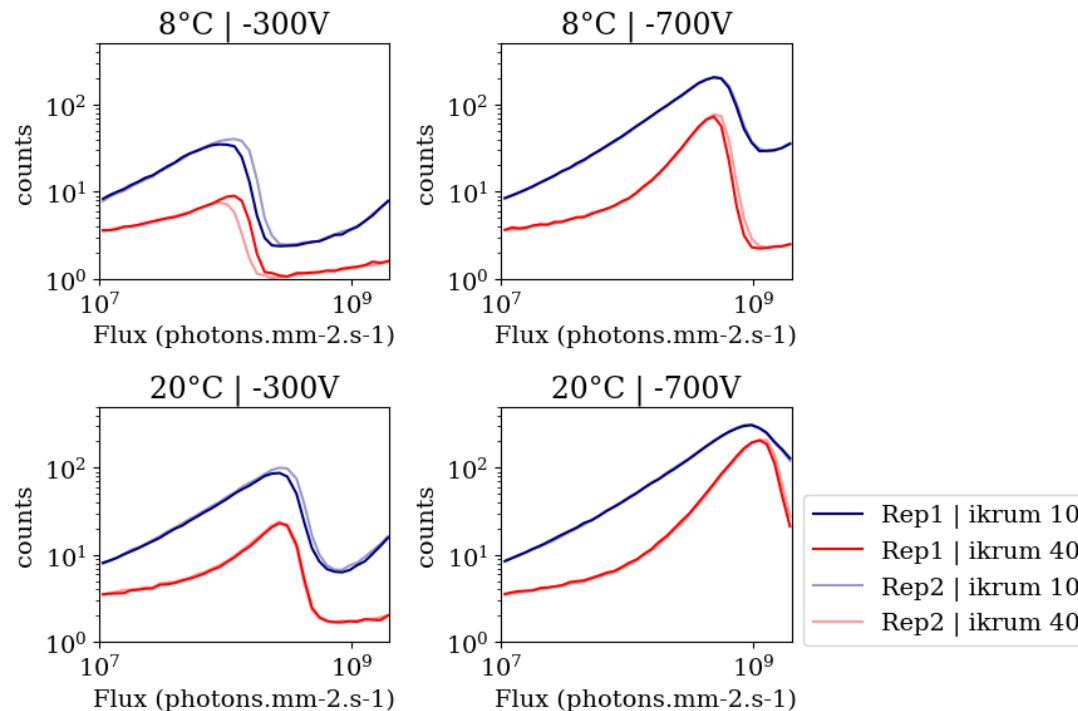




## • Linearity limit measurement

- Split plot experimental design<sup>(1)</sup> with 2 replicates
  - None randomized factors: Detector and Temperature
  - Randomized factors: Bias and ikrum
- The linearity limit is defined as highest photon flux for which the number of counts stays linear.

TSU-V2.2



(1) D. C. Montgomery, *Design and analysis of experiments*, Eighth edition. Hoboken, NJ: John Wiley & Sons, Inc, 2013.

- **Linearity limit measurement**

- Split plot experimental design<sup>(1)</sup> with 2 replicates
  - None randomized factors: Detector and Temperature
  - Randomized factors: Bias and ikrum
- The linearity limit is defined as highest photon flux for which the number of counts stays linear.

ikrum	replicates	rep1						rep2						
		detector	TSU-V3.2	TSU-V2.1	TSU-V1	TSU-V3.2	TSU-V2.1	TSU-V1	detector	TSU-V3.2	TSU-V2.1	TSU-V1		
	temperature	8°C	20°C	8°C	20°C	8°C	20°C	8°C	20°C	8°C	20°C	8°C	20°C	
10	bias	-300	105.0	65.0	110.0	70.0	100.0	70.0	110.0	65.0	100.0	70.0	100.0	65.0
	-700	55.0	40.0	50.0	25.0	50.0	30.0	55.0	50.0	50.0	25.0	50.0	30.0	
40	-300	110.0	70.0	100.0	70.0	105.0	65.0	105.0	70.0	110.0	70.0	105.0	65.0	
	-700	55.0	15.0	50.0	20.0	50.0	20.0	50.0	15.0	50.0	15.0	50.0	20.0	

(1) D. C. Montgomery, *Design and analysis of experiments*, Eighth edition. Hoboken, NJ: John Wiley & Sons, Inc, 2013.

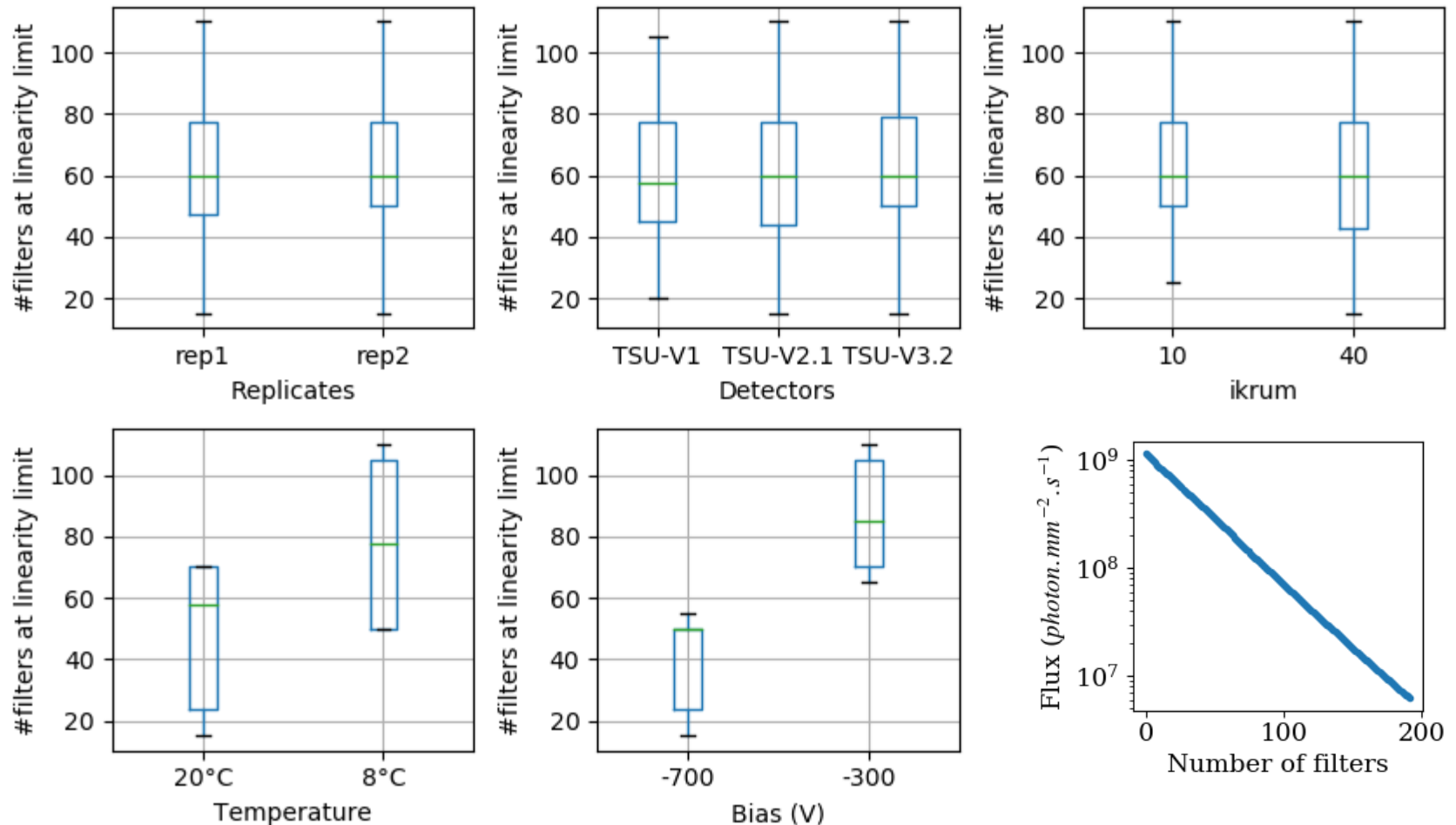
# LINEARITY WITH INCIDENT FLUX

Context  
○○

Characterizations and comparisons

○○○○○○○ ○○○●○ ○○○○○○

Conclusion  
○



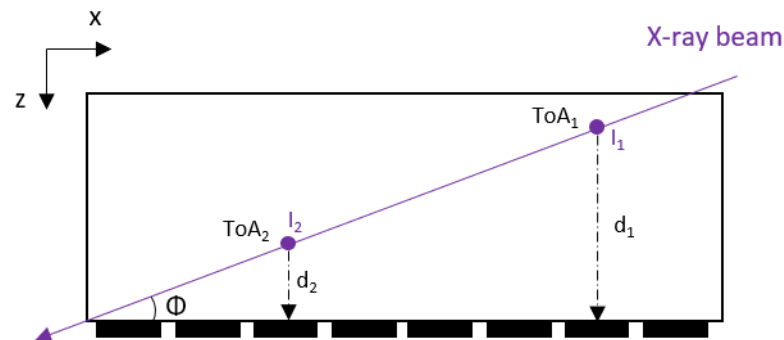
- ⇒ The linearity limit increases with both the temperature and the bias.
- ⇒ The linearity limit appears to be linked to the polarization effect which is mitigated at higher temperature and bias.

- **Takeaway messages for linearity limit of GaAs:Cr (ohmic)**
  - The higher the temperature, the higher the linearity limit.
  - The higher the bias, the higher the linearity limit.
  - Highest linearity limit recorded:  $1 \times 10^9$  ph.mm<sup>-2</sup>.s<sup>-1</sup> (20°C, -1.4kV/mm) before sensor breakdown

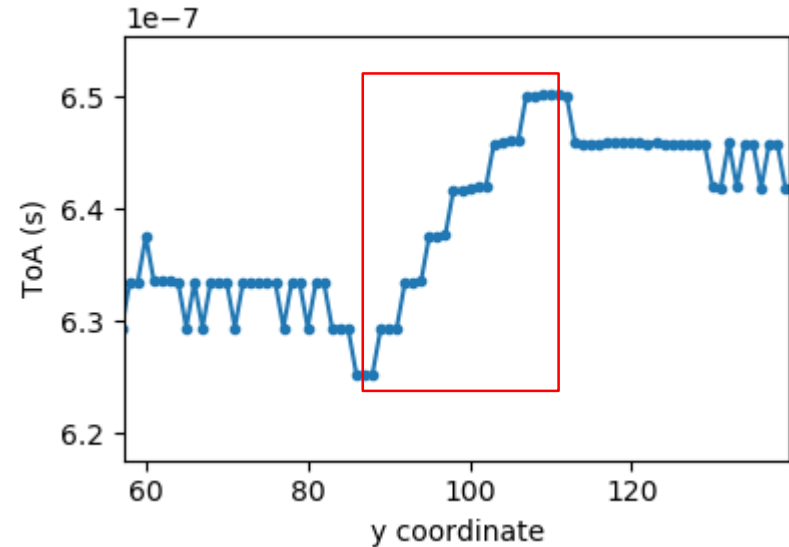
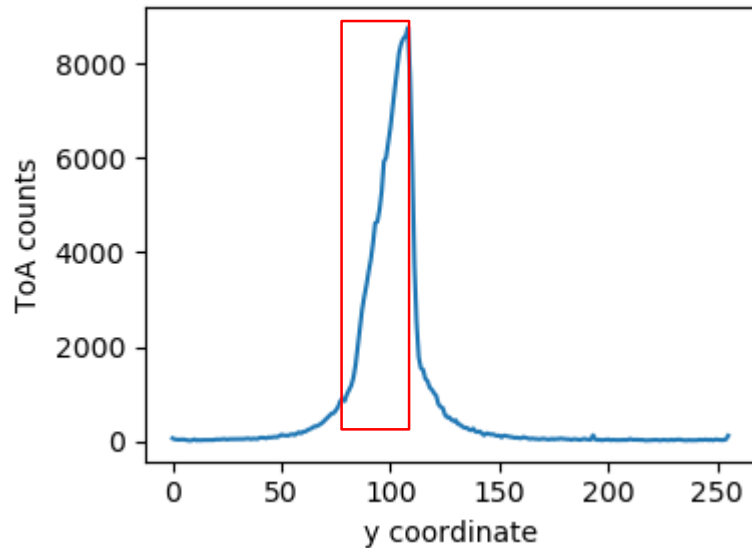
1. Context
2. Characterizations and comparisons
  1. Flood images and flat field correction
  2. Linearity with incident X-ray flux
  3. Charge transport properties
3. Conclusion and outlook

- **Setup grazing incidence measurements: electron drift velocity estimation**
  - Source: 50keV monochromatic synchrotron beam provided by the BM05 beamline of the ESRF (4-bunch mode)
  - Detectors tested: TSU-V2.2, TSU-V3.1, TSU-V3.2, ADV-V1 (only TPX3)
  - Parameters tested:
    - Temperature: 12°C, 24°C, 36°C
    - Electric field: -60V/mm to -160V/mm (20V/mm step)
  - Beam is focused on 1 pixel by compact transfocator (Al refractive lenses)
  - Sensor is tilted by an angle  $\Phi=19^\circ$  with respect to the beam
  - We measure the Time of Arrival for the line of pixels irradiated

$$v_{drift} = \frac{d_1 - d_2}{ToA_1 - ToA_2} = \frac{distance}{t_{transit}}$$

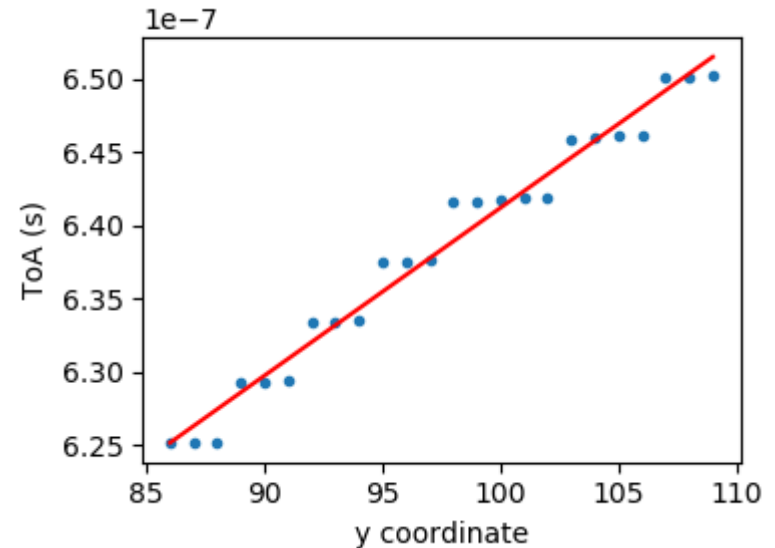
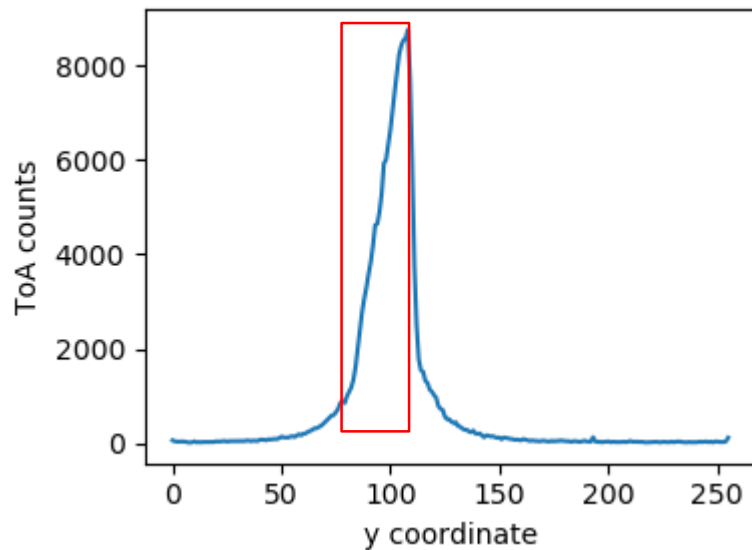


- **Measurement procedure for electron drift velocity**
  - ToA measurement is synchronous with the bunches
  - The ROI is defined by looking at the ToA counts as a function of the y coordinate (equivalent to depth in the sensor)



- **Measurement procedure for electron drift velocity**

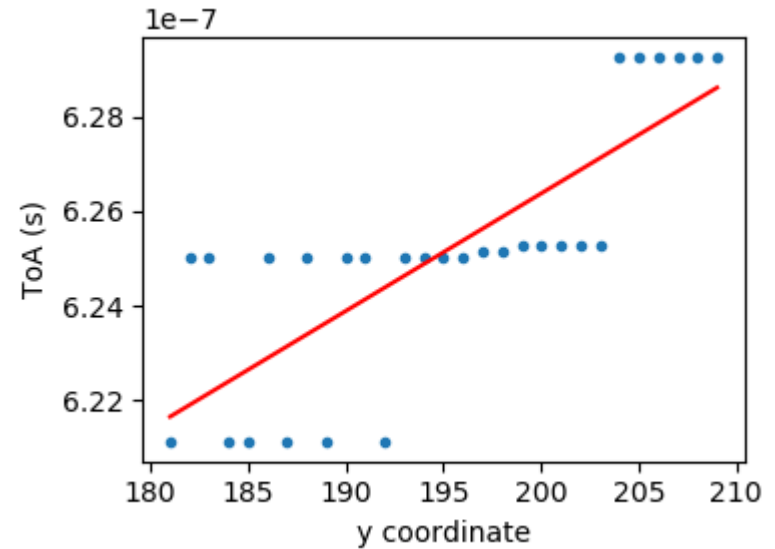
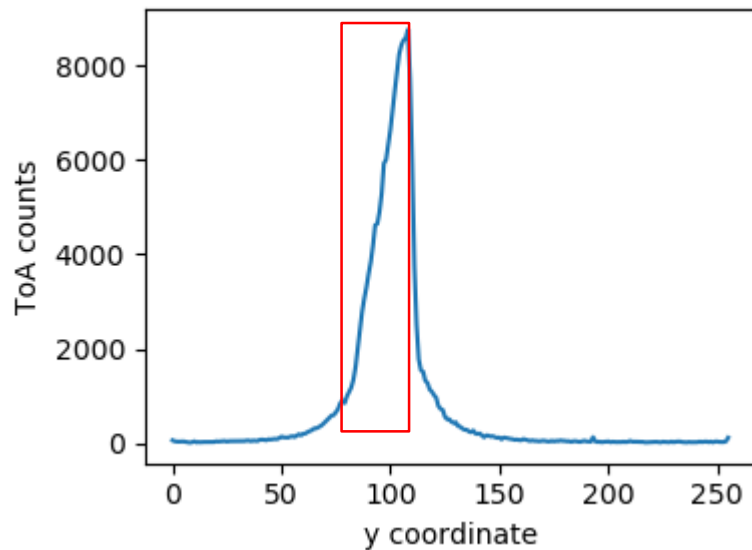
- ToA measurement is synchronous with the bunches
- The ROI is defined by looking at the ToA counts as a function of the y coordinate (equivalent to depth in the sensor)
- Linear regression of ToA VS y coordinate in the ROI to get the drift velocity





- **Measurement procedure for electron drift velocity**

- ToA measurement is synchronous with the bunches
- The ROI is defined by looking at the ToA counts as a function of the y coordinate (equivalent to depth in the sensor)
- Linear regression of ToA VS y coordinate in the ROI to get the drift velocity



- For some sets of parameters the drift velocity cannot be extracted

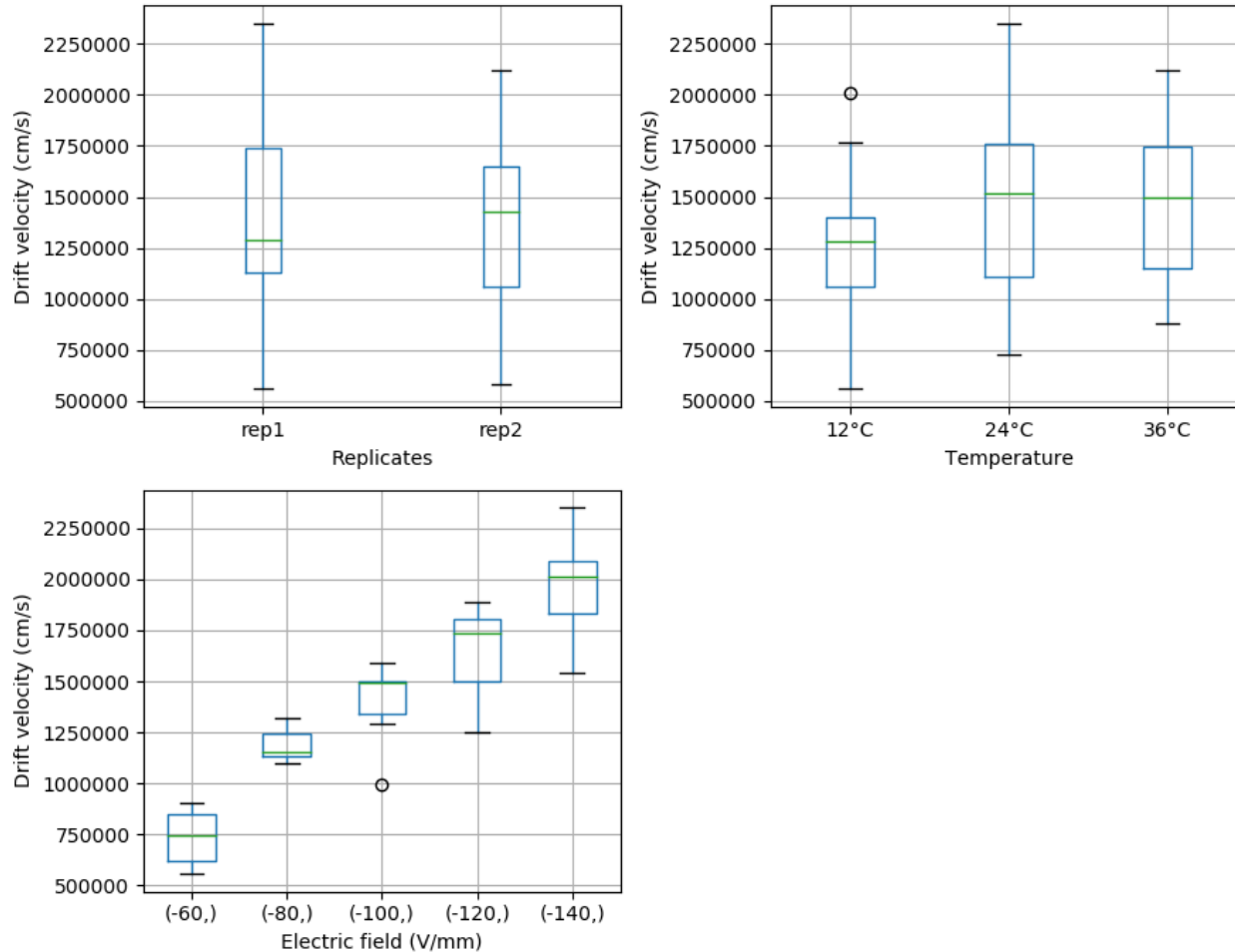
- Electron drift velocity

		electric field (V/mm)							
		-60	-80	-100	-120	-140	-160		
replicates	detector	temperature							
rep1	ADV-V1	12°C	559000.0	1270000.0	1290000.0	1250000.0	1770000.0	3000000.0	
		24°C	725000.0	1100000.0	1590000.0	1820000.0	2350000.0	3380000.0	
		36°C	878000.0	1160000.0	1500000.0	1710000.0	2010000.0	2980000.0	
	TSU-V3.2	12°C	NaN	529000.0	718000.0	853000.0	1460000.0	2070000.0	
		24°C	1450000.0	1530000.0	1510000.0	2890000.0	NaN	NaN	
		36°C	1210000.0	1390000.0	2360000.0	3600000.0	4680000.0	NaN	
	TSU-V3.1	12°C	713000.0	643000.0	679000.0	914000.0	932000.0	1140000.0	
		24°C	1170000.0	1450000.0	1390000.0	1310000.0	1980000.0	2970000.0	
		36°C	1490000.0	1820000.0	1430000.0	2120000.0	3000000.0	NaN	
TSU-V2.2	12°C	NaN	390000.0	812000.0	732000.0	1110000.0	2160000.0		
	24°C	NaN	375000.0	969000.0	1060000.0	1040000.0	3360000.0		
	36°C	NaN	NaN	304000.0	255000.0	542000.0	1880000.0		
rep2	ADV-V1	12°C	581000.0	1320000.0	993000.0	1430000.0	2010000.0	2520000.0	
		24°C	771000.0	1130000.0	1500000.0	1890000.0	1540000.0	1540000.0	
		36°C	902000.0	1150000.0	1490000.0	1760000.0	2120000.0	2630000.0	
	TSU-V3.2	12°C	1120000.0	862000.0	974000.0	1350000.0	1740000.0	2050000.0	
		24°C	NaN	1590000.0	1810000.0	NaN	NaN	NaN	
		36°C	1230000.0	1430000.0	2450000.0	3760000.0	4800000.0	NaN	
	TSU-V3.1	12°C	613000.0	634000.0	660000.0	702000.0	1470000.0	1380000.0	
		24°C	983000.0	1420000.0	1380000.0	1860000.0	2260000.0	NaN	
		36°C	1390000.0	1940000.0	NaN	1940000.0	2800000.0	3960000.0	
TSU-V2.2	12°C	NaN	629000.0	835000.0	1070000.0	908000.0	1580000.0		
	24°C	NaN	460000.0	963000.0	1750000.0	2340000.0	2880000.0		
	36°C	NaN	2320000.0	835000.0	2400000.0	NaN	5120000.0		

- Electron drift velocity

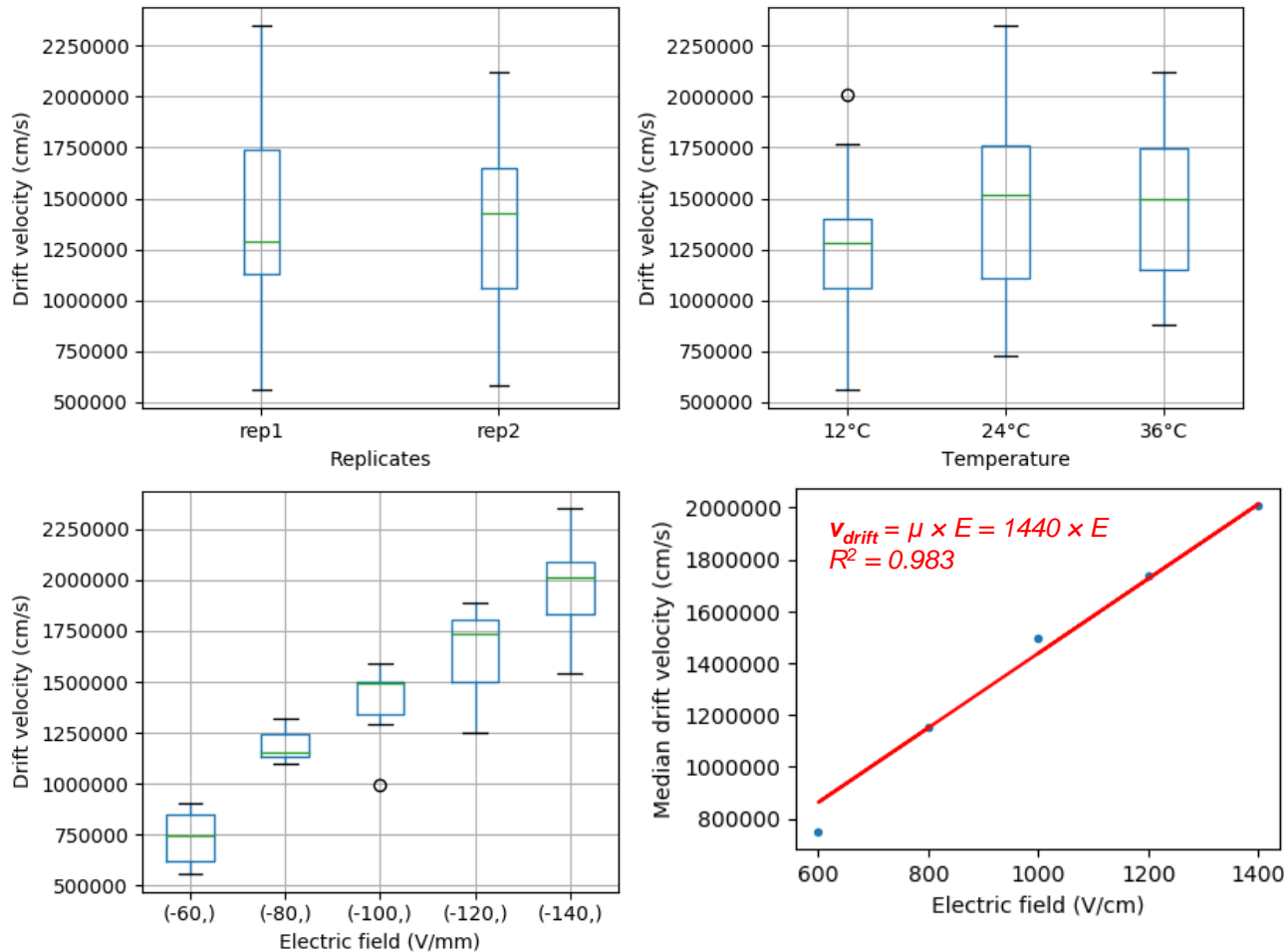
		electric field (V/mm)							
		-60	-80	-100	-120	-140	-160		
replicates	detector	temperature							
rep1	ADV-V1	12°C	559000.0	1270000.0	1290000.0	1250000.0	1770000.0	3000000.0	
		24°C	725000.0	1100000.0	1590000.0	1820000.0	2350000.0	3380000.0	
		36°C	878000.0	1160000.0	1500000.0	1710000.0	2010000.0	2980000.0	
	TSU-V3.2	12°C	NaN	529000.0	718000.0	853000.0	1460000.0	2070000.0	
		24°C	1450000.0	1530000.0	1510000.0	2890000.0	NaN	NaN	
		36°C	1210000.0	1390000.0	2360000.0	3600000.0	4680000.0	NaN	
	TSU-V3.1	12°C	713000.0	643000.0	679000.0	914000.0	932000.0	1140000.0	
		24°C	1170000.0	1450000.0	1390000.0	1310000.0	1980000.0	2970000.0	
		36°C	1490000.0	1820000.0	1430000.0	2120000.0	3000000.0	NaN	
TSU-V2.2	12°C	NaN	390000.0	812000.0	732000.0	1110000.0	2160000.0		
	24°C	NaN	375000.0	969000.0	1060000.0	1040000.0	3360000.0		
	36°C	NaN	NaN	304000.0	255000.0	542000.0	1880000.0		
rep2	ADV-V1	12°C	581000.0	1320000.0	993000.0	1430000.0	2010000.0	2520000.0	
		24°C	771000.0	1130000.0	1500000.0	1890000.0	1540000.0	1540000.0	
		36°C	902000.0	1150000.0	1490000.0	1760000.0	2120000.0	2630000.0	
	TSU-V3.2	12°C	1120000.0	862000.0	974000.0	1350000.0	1740000.0	2050000.0	
		24°C	NaN	1590000.0	1810000.0	NaN	NaN	NaN	
		36°C	1230000.0	1430000.0	2450000.0	3760000.0	4800000.0	NaN	
	TSU-V3.1	12°C	613000.0	634000.0	660000.0	702000.0	1470000.0	1380000.0	
		24°C	983000.0	1420000.0	1380000.0	1860000.0	2260000.0	NaN	
		36°C	1390000.0	1940000.0	NaN	1940000.0	2800000.0	3960000.0	
TSU-V2.2	12°C	NaN	629000.0	835000.0	1070000.0	908000.0	1580000.0		
	24°C	NaN	460000.0	963000.0	1750000.0	2340000.0	2880000.0		
	36°C	NaN	2320000.0	835000.0	2400000.0	NaN	5120000.0		

- **Electron drift velocity: example of ADV-V1**



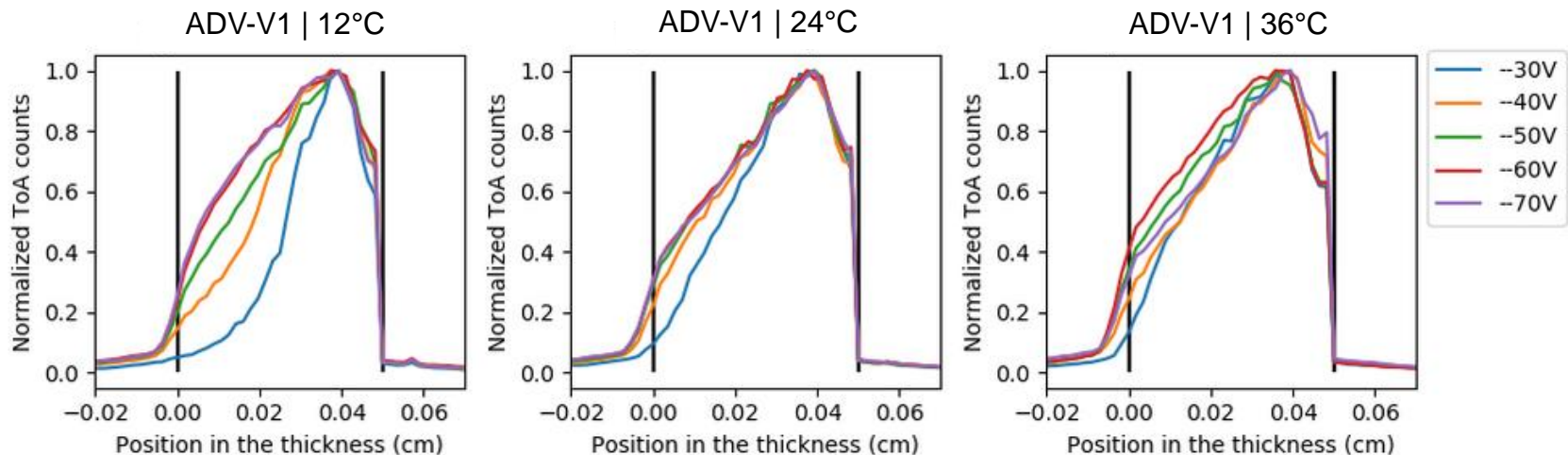
⇒ The drifts velocity depends only on electric field (saturation not reached)

- **Electron drift velocity: example of ADV-V1**



- ⇒ The drifts velocity depends only on electric field (saturation not reached)
- ⇒ Assuming constant electric field, the mobility is estimated to be  $1440 \text{ cm}^2 \cdot \text{V}^{-1} \cdot \text{s}^{-1}$

- **A few words about electric field distribution and electron mobility**
  - ToA count decorrelated from X-ray absorption VS depth would be constant in a sensor with constant electric field
  - Here it is obvious that the electric field distribution is not constant in the sensor so mobility estimation are to be taken with a grain of salt



- **General results**

- The linearity of the drift velocity with electric field is verified for all sensors (except for TSU-V3.2) and the saturation is not reached
- The average electron mobility for all sensors is about  $1500 \text{ cm}^2 \cdot \text{V}^{-1} \cdot \text{s}^{-1}$

- **Takeaway messages on charge transport properties**
  - Measuring transit time is a tricky balance between absorption, grazing angle, bias and time resolution of the chip.
  - Mobility estimation is difficult because the electric field distribution is not constant through the depth of the sensors.
  - For all of the sensors measured electron mobility has on average  $1500 \text{ cm}^2 \cdot \text{V}^{-1} \cdot \text{s}^{-1}$

1. Context
2. Characterizations and comparisons
  1. Flood images and flat field correction
  2. Linearity with incident X-ray flux
  3. Charge transport properties
3. Conclusion and outlook



- **GaAs:Cr sensors tested**

- 6 detectors
- 4 generations
- 5 sensors from TSU, 1 sensor from Advacam

- **Flood image and Flat field correction**

- Experience with TSU: sensor quality not reproducible within the same generation
- Advacam sensor is the best so far BUT only one was tested so no information on reproducibility yet

- **Linearity with incident X-ray flux at 30keV**

- Linearity limit due to sensor (polarization effects)
- Higher temperature and higher bias lead to higher linearity limit

- **Charge transport properties**

- Electric field distribution not constant in the GaAs detectors
- Electron mobility on average  $1500 \text{ cm}^2 \cdot \text{V}^{-1} \cdot \text{s}^{-1}$  for all detectors tested